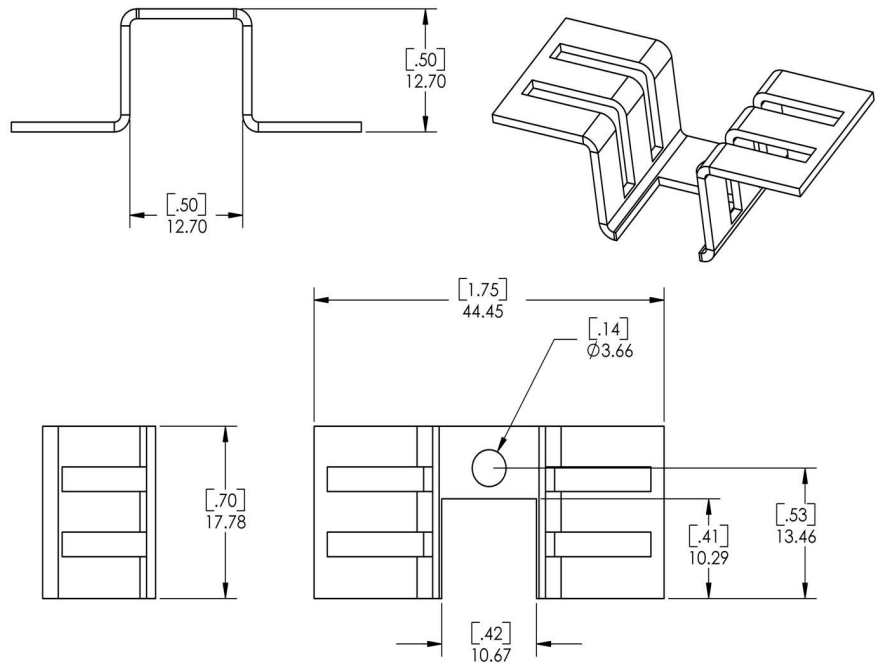
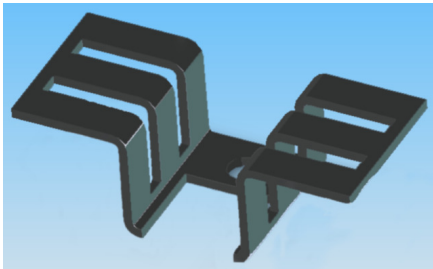


Board Level Heat Sinks



ThermaFlo

P/N: 822812B00000



PRODUCT SPECIFICATIONS

- Devices: TO-220
- Size: 17.8 x 44.5 x 12.7mm
- Material: Aluminum 1.0mm
- Type: Stamped
- Finish: Black Anodized
- Mounting: Device Leads
- Package: Bulk
- Accessories: Hardware & Thermal Interface Material

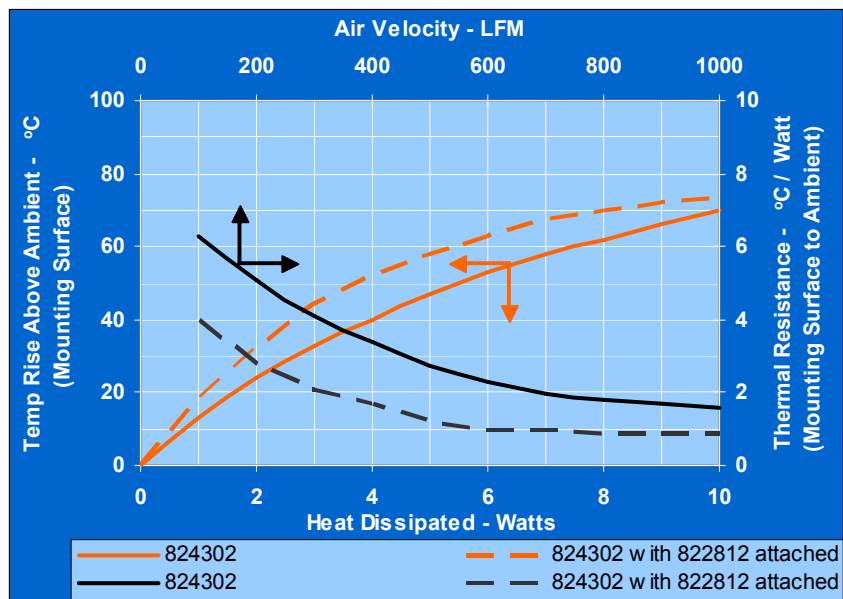
FEATURES & BENEFITS

- Hole for Device Attachment
- Mates with PN 824302B00000
- RoHS Compliant



CUSTOMIZED HEATSINKS

- Specialized Body Configurations
- Contact Applications Engineering



TO-220

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